

Title (en)

CONTACT DEVICE, PRINTED CIRCUIT BOARD CONNECTION DEVICE, AND METHOD OF MANUFACTURING SAID CONTACT DEVICE.

Title (de)

KONTAKTVORRICHTUNG, LEITERPLATTENANSCHLUSSVORRICHTUNG, UND VERFAHREN ZUR HERSTELLUNG DIESER KONTAKTVORRICHTUNG.

Title (fr)

DISPOSITIF DE CONTACT, DISPOSITIF DE CONNEXION DE CIRCUITS IMPRIMÉS, ET PROCÉDÉ DE FABRICATION DE CE DISPOSITIF DE CONTACT.

Publication

**EP 3526858 B1 20220727 (DE)**

Application

**EP 17762098 A 20170904**

Priority

- DE 102016119611 A 20161014
- EP 2017072047 W 20170904

Abstract (en)

[origin: WO2018068946A1] The invention relates to a contact device comprising at least one terminal contact (4.1, 4.2, 4.3, 4.4, 4.5, 4.6; 104.1, 104.2, 104.3, 104.4, 104.5, 104.6), a contact clamping mechanism (7.1,..., 7.n; 107.1, ..., 107.n), and a contact accommodation unit (2, 3; 102, 103) in the form of a substantially rectangular contact plate (2; 102) which is provided with a contact hole (3; 103). A lateral plate (5, 6; 105; 106) having terminal contacts (4.1, 4.2, 4.3, 4.4, 4.5, 4.6; 104.1, 104.2, 104.3, 104.4, 104.5, 104.6) is located on at least one side of the contact plate (2; 102), and the contact clamping mechanism is in the form of clamping elements (7.1,..., 7.n; 107.1, ..., 107.n) which are located on at least one additional side of the contact plate (2; 102).

IPC 8 full level

**H01R 13/11** (2006.01); **H01R 12/55** (2011.01); **H01R 12/70** (2011.01); **H01R 43/16** (2006.01)

CPC (source: EP US)

**H01R 12/55** (2013.01 - EP US); **H01R 12/585** (2013.01 - US); **H01R 12/7088** (2013.01 - EP US); **H01R 13/113** (2013.01 - EP US); **H01R 43/16** (2013.01 - EP US); **H01R 12/58** (2013.01 - EP)

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)

**WO 2018068946 A1 20180419**; CN 109845042 A 20190604; CN 109845042 B 20211207; DE 102016119611 A1 20180419; EP 3526858 A1 20190821; EP 3526858 B1 20220727; ES 2927005 T3 20221031; US 10804634 B2 20201013; US 2019237893 A1 20190801

DOCDB simple family (application)

**EP 2017072047 W 20170904**; CN 201780063659 A 20170904; DE 102016119611 A 20161014; EP 17762098 A 20170904; ES 17762098 T 20170904; US 201916383267 A 20190412